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April 2008

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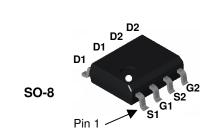
Dual N & P-Channel PowerTrench[®] MOSFET

General Description

These dual N- and P-Channel enhancement mode power field effect transistors are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state ressitance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.





Features

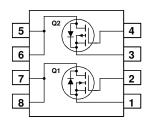
• Q1: N-Channel

7.0A, 30V $R_{DS(on)} = 0.028\Omega @ V_{GS} = 10V$ $R_{DS(on)} = 0.040\Omega @ V_{GS} = 4.5V$

Q2: P-Channel

-5A, -30V $R_{DS(on)} = 0.052\Omega @ V_{GS} = -10V$ $R_{DS(on)} = 0.080\Omega @ V_{GS} = -4.5V$

- Fast switching speed
- High power and handling capability in a widely used surface mount package



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Q2 Units		
V _{DSS}	Drain-Sourc	e Voltage		30	30	V	
V _{GSS}	Gate-Source	e Voltage		±20 ±20		V	
ID	Drain Curre	nt - Continuous	(Note 1a)	7	-5		
		- Pulsed		20	-20	А	
P _D	Power Dissipation for Dual Operation			2	2		
	Power Dissipation for Single Operation		n (Note 1a)	1.6	1.6	W	
		(Note 1c)	0.9	0.9	7		
E _{AS}	Single Pulse	e Avalanche Energy	(Note 3)	54	13	mJ	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		perature Range	-55 to +150		°C	
Therma R _{θJA} R _{θJC}		teristics sistance, Junction-to-Amb sistance, Junction-to-Cas	, ,	78		°C/W °C/W	
	e Markin	g and Ordering I		Таре и		Quantity	
FDS8958A		FDS8958A	13"	 12m	im	2500 units	

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Symbol	Parameter	Test	Туре	Min	Тур	Мах	Units	
Off Cha	racteristics							
BV _{DSS}	Drain-Source Breakdown Voltage		I _D = -250 μA	Q1 Q2	30 -30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_{D} = 250 \ \mu A, \ R$	leferenced to 25°C	Q1 Q2		25 -23		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V,$ $V_{DS} = -24 V,$	Referenced to $25^{\circ}C$ $V_{GS} = 0 V$ $V_{GS} = 0 V$	Q1 Q2			1 -1	μA
GSSF	Gate-Body Leakage, Forward	$V_{DS} = -24 V,$ $V_{GS} = 20 V,$	$V_{DS} = 0 V$	All			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$,	$V_{DS} = 0 V$	All			-100	nA
On Cha	racteristics (Note 2)							
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS},$ $V_{DS} = V_{GS},$	I _D = 250 μA I _D = -250 μA	Q1 Q2	1 -1	1.9 -1.7	3 -3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage	$I_D=250~\mu A,~Re$	eferenced to 25°C eferenced to 25°C	Q1 Q2		-4.5 4.5		mV/°C
R _{DS(on)}	On-Resistance	$V_{GS} = 4.5 V$,	= 7 A, T _J = 125°C I _D = 6 A	Q1		19 27 24	28 42 40	mΩ
		$V_{GS} = -10 V,$ $V_{GS} = -10 V, I_{D}$	I _D = -5 A = -5 A, T _J = 125°C	Q2		42 57 65	52 78 80	
D(on)	On-State Drain Current	$\label{eq:VGS} \begin{split} &V_{GS} = -4.5 \ V, \\ &V_{GS} = 10 \ V, \\ &V_{GS} = -10 \ V, \\ &V_{DS} = 5 \ V, \end{split}$	$V_{DS} = 5 V$ $V_{DS} = -5 V$	Q1 Q2	20 -20			A
g fs				Q1 Q2		25 10		S
Dynami	c Characteristics							
C _{iss}		Q1 V _{DS} = 15 V, V _{GS}	= 0 V, f = 1.0 MHz	Q1 Q2		575 528		pF
C _{oss}	Output Capacitance	Q2		Q1 Q2		145 132		pF
C _{rss}	Reverse Transfer Capacitance	$V_{DS} = -15 V, V_{C}$	_{as} = 0 V, f = 1.0 MHz	Q1 Q2		65 70		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV},$	f = 1.0 MHz	Q1 Q2		2.1 6.0		Ω

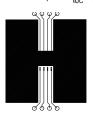
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FDS8958A Rev F3 (W)

Electri	cal Characteristics	(continued) $T_A = 25 ^{\circ}\text{C}$ unless othe	rwise noted	I			
Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Switchi	ng Characteristics (Note	2)					
t _{d(on)}	Turn-On Delay Time	Q1 V _{DD} = 15 V, I _D = 1 A,	Q1 Q2		8 7	16 14	ns
t _r	Turn-On Rise Time	V_{GS} = 10V, R_{GEN} = 6 Ω	Q1 Q2		5 13	10 24	ns
t _{d(off)}	Turn-Off Delay Time	Q2 V _{DD} = -15 V, I _D = -1 A,	Q1 Q2		23 14	37 25	ns
t _f	Turn-Off Fall Time	V_{GS} = -10V, R_{GEN} = 6 Ω	Q1 Q2		3 9	6 17	ns
Qg	Total Gate Charge	Q1 V _{DS} = 15 V, I _D = 7 A, V _{GS} = 10 V	Q1 Q2		11.4 9.6	16 13	nC
Q_{gs}	Gate-Source Charge	Q2	Q1 Q2		1.7 2.2		nC
Q _{gd}	Gate-Drain Charge	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -5 \text{ A}, \text{V}_{GS} = -10 \text{ V}$	Q1 Q2		2.1 1.7		nC
Drain-S	Source Diode Character	ristics and Maximum Rating	S				
ls	Maximum Continuous Drain-Source Diode Forward Current					1.3 -1.3	A
I _{SM}	Maximum Plused Drain-Source Diode Forward Current (Note 2)					20 -20	A
V _{SD}	Drain-Source Diode Forward Voltage		Q1 Q2		0.75 -0.88	1.2 -1.2	V
t _{rr}	Diode Reverse Recovery Time	Q1 I _F = 7 A, d _i /d _t = 100 A/μs	Q1 Q2		19 19		nS
Q _{rr}	Diode Reverse Recovery Charge	Q2 Ι _F = -5 A, d _{iF} /d _t = 100 A/μs	Q1 Q2		9 6		nC

Notes:

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 78°/W when mounted on a 0.5 in² pad of 2 oz copper



b) 125°/W when mounted on a .02 in² pad of 2 oz copper

c) 135 °/W when mounted on a minimum pad.

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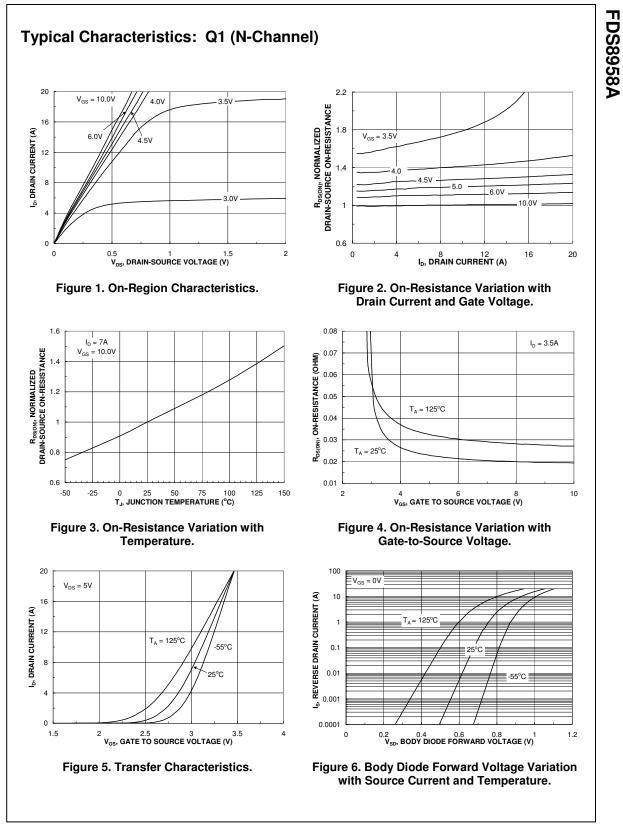
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Scale 1 : 1 on letter size paper

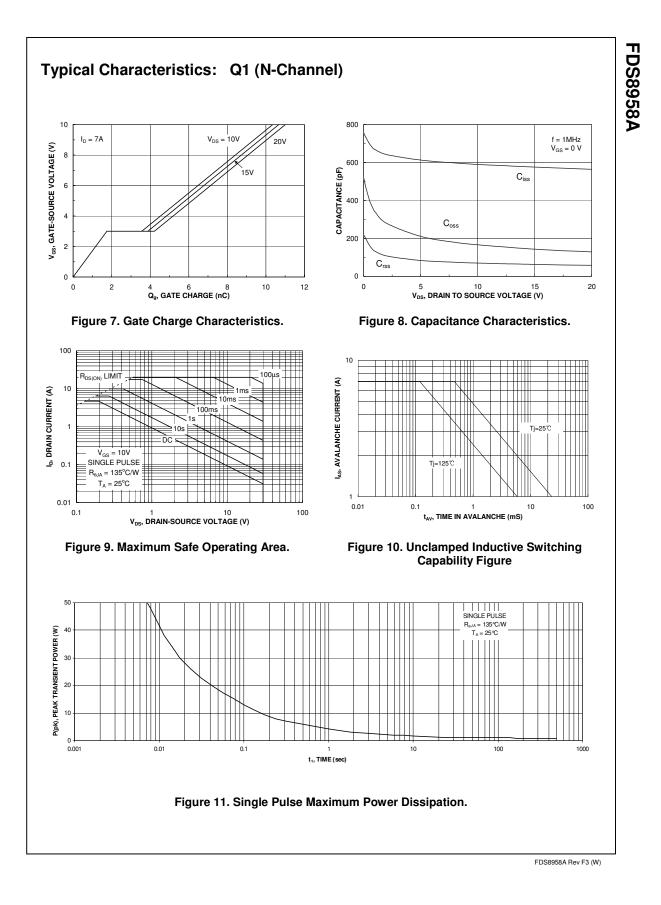
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

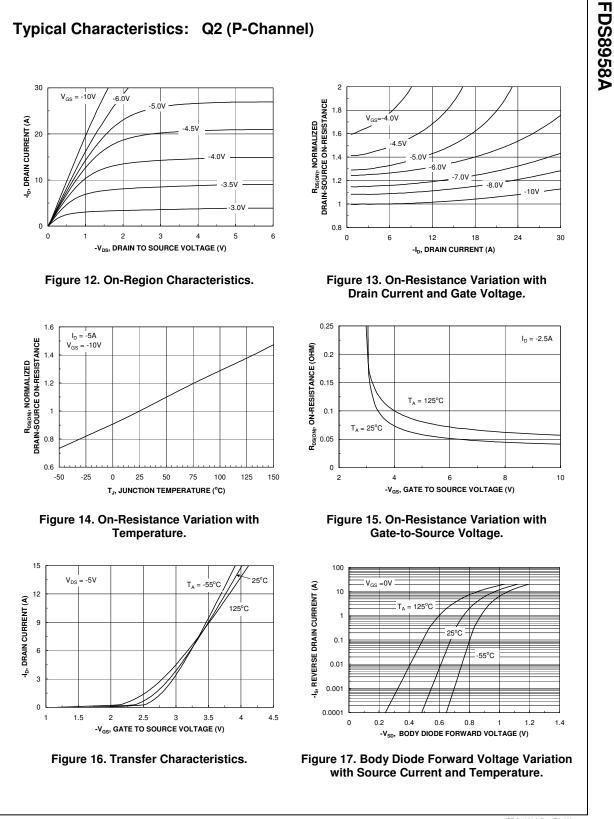
3. Starting TJ = 25 °C, L = 3mH, I_{AS} = 6A, V_{DD} = 30V, V_{GS} = 10V (Q1).

Starting TJ = 25 °C, L = 3mH, I_{AS} = 3A, V_{DD} = 30V, V_{GS} = 10V (Q2).

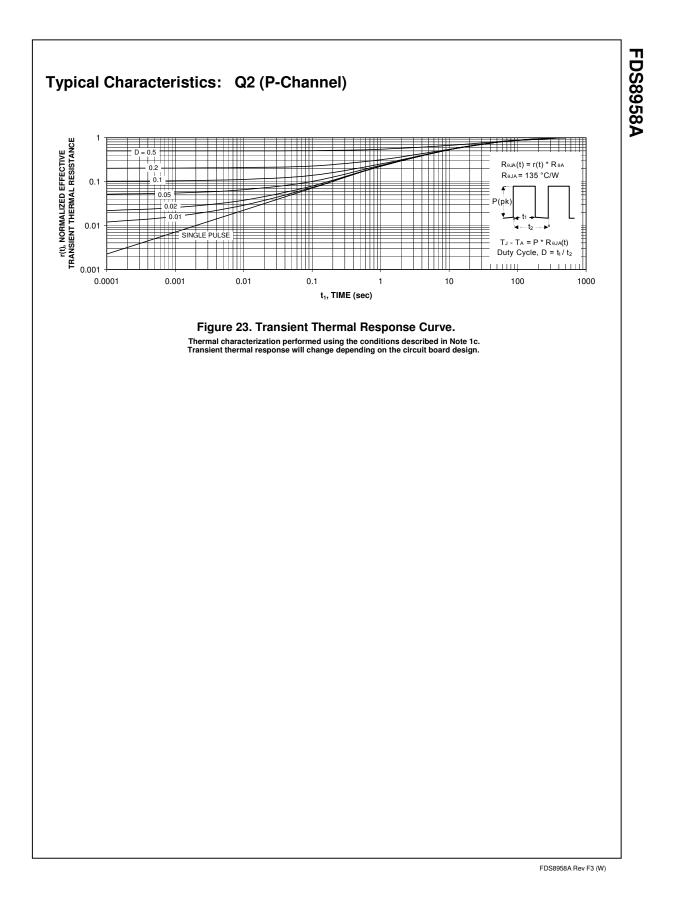


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